

STA400EP Enhanced Plastic Dual 2:1 Analog Mux with IEEE 1149.4

General Description

This Dual 2 to 1 Analog Mux with IEEE 1149.4 incorporates many features of the IEEE 1149.4 Test Standard. The device provides access to up to 9 Analog test points and can be used to sample Analog signals as well as assist in the measurement of passive components. The device can be configured as a dual 2 to 1 multiplexor, or in a single 4 to 1 format. The device is compliant with both IEEE 1149.1 and IEEE 1149.4 Boundary Scan Test Standards.

ENHANCED PLASTIC

- Extended Temperature Performance of -55°C to +125°C
- · Baseline Control Single Fab & Assembly Site
- Process Change Notification (PCN)
- Qualification & Reliability Data
- Solder (PbSn) Lead Finish is standard
- Enhanced Diminishing Manufacturing Sources (DMS) Support

Features

- Compliant to IEEE 1149.1 and IEEE 1149.4
- Analog mux/demux either dual 2 to 1 or single 4 to 1
- Samples up to 9 Analog test points
 - Includes CLAMP and HIGHZ instructions
- TRST Input

■ Input range from -0.5V to +6.5

Applications

- Industrial Applications
- Automotive Applications
- Selected Military Applications
- Selected Avionics Applications

Ordering Information

PART NUMBER	VID PART NUMBER	NS PACKAGE NUMBER (Note 1)		
STA400MTEP	V62/04727-01	MTC20		

Note 1: Refer to package details under Physical Dimensions

Block Diagram



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Connection Diagram



Pinout Description

Pin #	Input/ Output	Descriptions
1, 2, 4, 5	I/O	Analog Multiplexor Input/IEEE 1149.4 Analog Access Pin
17, 19	I/O	Analog Multiplexor Output/IEEE 1149.4 Analog Access Pin
18, 3	I/O	Analog Multiplexor Select/IEEE 1149.4 Analog Access Pin
8	I/O	Analog Multiplexor Mode/IEEE 1149.4 Analog Access Pin
6, 11	I	Analog Multiplexor Mode/Test Mode Select
10	Ground	Ground
20	Power	Power
9	0	Analog Current Source for IEEE 1149.4
7	I	Analog Voltage Monitor for IEEE 1149.4
16	I	Test Reset Input for IEEE 1149.1
12	I	Test Mode Select for IEEE 1149.1
13	I	Test Clock for IEEE 1149.1
15	Ι	Test Data Input for IEEE 1149.1
14	0	Test Data Output for IEEE 1149.1
	Pin # 1, 2, 4, 5 17, 19 18, 3 8 6, 11 10 20 9 7 16 12 13 15 14	Pin # Input/ Output 1, 2, 4, 5 I/O 17, 19 I/O 18, 3 I/O 8 I/O 6, 11 I 10 Ground 20 Power 9 O 7 I 16 I 12 I 13 I 15 I 14 O

Truth Table

CE	Mode	C1	со	A01	A23	
not equal to CEI	0	0	0	A0	A2	
	0	0	1	A1	A2	
	0	1	0	A0	A3	
	0	1	1	A1	A3	
	1	0	0	A0	not connected	
	1	0	1	A1	not connected	
	1	1	0	not connected	A2	
	1	1	1	not connected	A3	
equal to CEI (Note 2)	Х	Х	Х	not connected	not connected	

Note 2: When CEI = CE, the analog pins can be used as analog probes in IEEE 1149.4.

STA400EP Enhanced Plastic

Absolute Maximum Ratings (Note 3)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage (V _{CC})	6.5V
DC Input/Out Voltage	–0.5V to V $_{\rm CC}$
	+0.5V
Storage Temperature	-65C to +150C

Recommended Operating Conditions

Supply Voltage (V_{CC}) Operating Temperature (T_A)

3.0V to 5.5V -55°C to +125°C

Note 3: Absolute maximum ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. National does not recommend operation of SCAN circuits outside databook specifications.

2.56

1.31

DC Electrical Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Units	
V _{IL}	Maximum Input Low Voltage				0.8	V	
V _{IH}	Minimum Input High Voltage		2.0			V	
I _{IN}	Input Leakage Current	All Inputs	-200		5	μA	
l _{oz}	Tristate Output Current	(TDO only)	-5		5	μA	
V _{OL}	Output Low Voltage	I _{OL} = 100uA (TDO only)			0.2	V	
	Output Low Voltage	I _{OL} = 12mA (TDO only)			0.5	V	
V _{OH}	Output High Voltage	I _{OH} = -100uA (TDO only)	V _{CC} - 0.2v			V	
	Output High Voltage	I _{OH} = -12mA (TDO only)	2.4			V	
I _{CCL}	Power Supply Current	$V_{\rm CC} = 3.0 V$			400	μA	
I _{CCH}					40	μA	
I _{CCT}					500	μA	
I _{CCL}	Power Supply Current	$V_{\rm CC} = 5.5 V$			1	mA	
I _{CCH}					80	μA	
I _{CCT}					500	μA	
I _{CCT2}		TCK, TMS, TDI, TRST active			2.0	mA	
CIN	Input Capacitance	C0, C1, Mode		8		pF	
	(Note 4)	A0, A1, A2, A3		12		pF	
		A01, A23		16		pF	
MUX Elect	trical Characteristics Over	recommended operating supply and temperat	ure ranges i	unless othe	rwise specifi	ied.	
R _{ON}	Mux Switch On	A01 to A0 or A1, A23 to A2 or A3	5		50	Ω	
	Resistance						
	(Note 4)						
ABM Electrical Characteristics (Muxes disconnected) Over recommended operating supply and temperature ranges unless otherwise specified.							
R _{ON}	Test Bus Path Resistance	AT1 or AT2 to any input with ABM	400		2000	Ω	
		(A01, A23, A0, A1, A2, A3, C0, C1)					

Note 4: Not production tested.

(Note 4)

Threshold Voltage

 V_{TH}

AC Electrical Characteristics

 $V_{\rm CC} = 5.5 V$

 $V_{\rm CC} = 3.0V$

Symbol	Parameter	Conditions	Min	Тур	Мах	Units
t _{PLH}	Propagation Delay	TDO Output	0.5		9.5	ns
t _{PHL}	Propagation Delay	TDO Output	0.5		9.5	ns
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Applications Examples



FIGURE 1. Nine (9) IEEE 1149.4 probes



FIGURE 2. Single 4 to 1 Multiplexer



FIGURE 3. Dual 2 to 1 Multiplexer



FIGURE 4. Single 8 to 1 Multiplexer



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